Label Table

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
</tr>
</thead>
<tbody>
<tr>
<td>001</td>
<td>ISTA-EVM-00561</td>
</tr>
<tr>
<td>002</td>
<td>OrangeMe!</td>
</tr>
</tbody>
</table>

PCB Number: TIDA-00561
PCB Rev: E1

Texas Instruments

Label Assembly Note

ZZ1
This Assembly Note is for PCB labels only

ZZ2
These assemblies are ESD sensitive; ESD precautions shall be observed.

ZZ3
These assemblies must be clean and free from flux and all contaminants. Use of no-clean flux is not acceptable.

ZZ4
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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